**Features** 

# 

## 670MHz LVDS-to-LVDS and Anything-to-LVDS 1:2 Splitters

### **General Description**

The MAX9174/MAX9175 are 670MHz, low-jitter, lowskew 1:2 splitters ideal for protection switching, loopback, and clock and signal distribution. The devices feature ultra-low 1.0ps(RMS) random jitter (max) that ensures reliable operation in high-speed links that are highly sensitive to timing errors.

The MAX9174 has a fail-safe LVDS input and LVDS outputs. The MAX9175 has an anything differential input (CML/LVDS/LVPECL) and LVDS outputs. The outputs can be put into high impedance using the power-down inputs. The MAX9174 features a fail-safe circuit that drives the outputs high when the input is open, undriven and shorted, or undriven and terminated. The MAX9175 has a bias circuit that forces the outputs high when the input is open. The power-down inputs are compatible with standard LVTTL/LVCMOS logic. The power-down inputs tolerate undershoot of -1V and overshoot of VCC + 1V. The MAX9174/MAX9175 are available in 10-pin µMAX and 10-lead thin QFN with exposed pad packages, and operate from a single +3.3V supply over the -40°C to +85°C temperature range.

#### **Applications**

Protection Switching Loopback Clock Distribution

Functional Diagram and Pin Configurations appear at end of data sheet.

#### ♦ 1.0ps(RMS) Jitter (max) at 670MHz

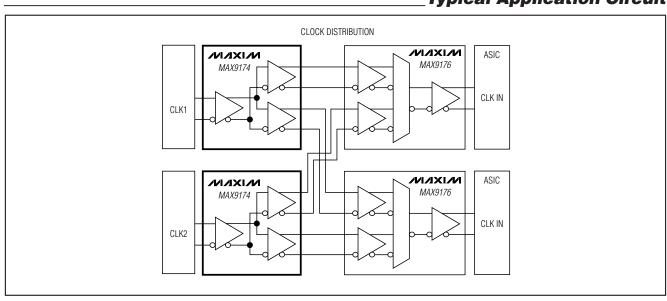
- ♦ 80ps<sub>(P-P)</sub> Jitter (max) at 800Mbps Data Rate
- ♦ +3.3V Supply
- ♦ LVDS Fail-Safe Inputs (MAX9174)
- ♦ Anything Input (MAX9175) Accepts Differential CML/LVDS/LVPECL
- ♦ Power-Down Inputs Tolerate -1.0V and V<sub>CC</sub> + 1.0V
- **♦ Low-Power CMOS Design**
- ♦ 10-Lead µMAX and Thin QFN Packages
- ♦ -40°C to +85°C Operating Temperature Range
- ♦ Conform to ANSI TIA/EIA-644 LVDS Standard
- ♦ IEC 61000-4-2 Level 4 ESD Rating

### **Ordering Information**

| PART        | TEMP RANGE     | PIN-PACKAGE      |
|-------------|----------------|------------------|
| MAX9174EUB  | -40°C to +85°C | 10 μMAX          |
| MAX9174ETB* | -40°C to +85°C | 10 Thin QFN-EP** |
| MAX9175EUB  | -40°C to +85°C | 10 μMAX          |
| MAX9175ETB* | -40°C to +85°C | 10 Thin QFN-EP** |

<sup>\*</sup>Future product—contact factory for availability.

### **Typical Application Circuit**



NIXIN

Maxim Integrated Products 1

<sup>\*\*</sup>EP = Exposed paddle.

#### **ABSOLUTE MAXIMUM RATINGS**

| V <sub>CC</sub> to GND0.3V to +4.0V                   |
|---|
| IN+, IN- to GND0.3V to +4.0V                          |
| OUT_+, OUT to GND0.3V to +4.0V                        |
| PD0, PD1 to GND1.4V to (V <sub>CC</sub> + 1.4V)       |
| Single-Ended and Differential Output                  |
| Short-Circuit Duration (OUT_+, OUT)Continuous         |
| Continuous Power Dissipation ( $T_A = +70^{\circ}C$ ) |
| 10-Pin µMAX (derate 5.6mW/°C above +70°C)444mW        |
| 10-Lead QFN (derate 24.4mW/°C above +70°C) 1951mW     |
| Maximum Junction Temperature+150°C                    |

| Storage Temperature Range ESD Protection                                  | 65°C to +150°C |
|---|----------------|
| Human Body Model ( $R_D = 1.5k\Omega$ , $C_S = 100p$                      | oF)            |
| IN+, IN-, OUT +, OUT  |                |
| Other Pins (V <sub>CC</sub> , PD0, PD1)                                   |                |
| IEC 61000-4-2 Level 4 (R <sub>D</sub> = $330\Omega$ , C <sub>S</sub> = 15 |                |
| Contact Discharge IN+, IN-, OUT_+, OUT                                    | ±8kV           |
| Air-Gap Discharge IN+, IN-, OUT_+, OUT                                    |                |
| Lead Temperature (soldering, 10s)   | +300°C         |
|   |                |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +3.0 \text{V to } +3.6 \text{V}, R_L = 100\Omega \pm 1\%, \overline{PD}_- = \text{high, differential input voltage } |V_{ID}| = 0.05 \text{V to } 1.2 \text{V, MAX9174 input common-mode voltage } |V_{CC}| = |V_{ID}|/2 \text{I to } (2.4 \text{V} - |V_{ID}|/2), MAX9175 input common-mode voltage } |V_{CM}| = |V_{ID}|/2 \text{I to } (V_{CC} - |V_{ID}|/2), T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } |V_{CC}| = +3.3 \text{V, } |V_{ID}| = 0.2 \text{V, } |V_{CM}| = +1.25 \text{V, } |V_{CM}| = +25 ^{\circ}\text{C.} \text{)} \text{ (Notes 1, 2, 3)}$ 

| PARAMETER   | SYMBOL                                 |                         | CONDITIONS  | MIN   | TYP  | MAX               | UNITS            |
|---|--|-------------------------|---|-------|------|-------------------|------------------|
| DIFFERENTIAL INPUT (IN+, IN-)                                 |  |                         |   |       |      |                   |                  |
| Differential Input High Threshold                             | VTH                                    |                         |   |       |      | +50               | mV               |
| Differential Input Low Threshold                              | VTL                                    |                         |   | -50   |      |                   | mV               |
| Input Current   | I <sub>IN+</sub> , I <sub>IN-</sub>    | Figure 1                |   | -20   |      | +20               | μΑ               |
|   |  | MAX9174                 | V <sub>CC</sub> = 0V or open, Figure 1                                    |       |      |                   |                  |
| Power-Off Input Current                                       | I <sub>IN+,</sub><br>I <sub>IN</sub> - | MAX9175                 | $V_{IN+}=3.6V$ or 0V, $V_{IN-}=3.6V$ or 0V, $V_{CC}=0V$ or open, Figure 1 | -20   |      | +20               | μΑ               |
| Fail-Safe Input Resistors                                     | R <sub>IN1</sub>                       | V 0.0V                  | OV or once Figure 1   | 60    |      | 108               | l <sub>1</sub> O |
| (MAX9174)   | R <sub>IN2</sub>                       | VCC = 3.6V              | , OV or open, Figure 1  | 200   |      | 394               | kΩ               |
| Input Resistors<br>(MAX9175)                                  | RIN3                                   | V <sub>CC</sub> = 3.6V, | , 0V or open, Figure 1  | 212   |      | 450               | kΩ               |
| Input Capacitance   | CIN                                    | IN+ or IN- to           | GND (Note 4)  |       |      | 4.5               | рF               |
| LVTTL/LVCMOS INPUTS (PDO, F                                   | PD1)                                   |                         |   |       |      |                   |                  |
| Input High Voltage  | VIH                                    |                         |   | 2.0   |      | V <sub>CC</sub> + | ٧                |
| Input Low Voltage   | V <sub>IL</sub>                        |                         |   | -1.0  |      | +0.8              | V                |
|   |  | -1.0V ≤ PD_             | _ ≤ 0V  | -1.5  |      |                   | mA               |
| Input Current   | I <sub>IN</sub>                        | 0V ≤ PD_≤               | Vcc   | -20   |      | +20               | μΑ               |
|   |  | V <sub>CC</sub> ≤ PD_ s | ≤ V <sub>CC</sub> + 1.0V  |       |      | +1.5              | mA               |
| LVDS OUTPUTS (OUT_+, OUT                                      | )                                      |                         |   |       |      |                   |                  |
| Differential Output Voltage                                   | V <sub>OD</sub>                        | Figure 2                |   | 250   | 393  | 475               | mV               |
| Change in Differential Output<br>Voltage Between Logic States | ΔV <sub>OD</sub>                       | Figure 2                |   |       | 1.0  | 15                | mV               |
| Offset Voltage  | Vos                                    | Figure 3                |   | 1.125 | 1.29 | 1.375             | V                |

\_\_\_\_\_ /VI/IXI/VI

#### DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC}=+3.0V\ to\ +3.6V,\ R_L=100\Omega\ \pm1\%,\ \overline{PD}_=\ high,\ differential\ input\ voltage\ |V_{ID}|=0.05V\ to\ 1.2V,\ MAX9174\ input\ common-mode\ voltage\ V_{CM}=|V_{ID}|/2|\ to\ (2.4V-|V_{ID}|/2|),\ MAX9175\ input\ common-mode\ voltage\ V_{CM}=|V_{ID}|/2|\ to\ (V_{CC}-|V_{ID}|/2|),\ T_A=-40^{\circ}C\ to\ +85^{\circ}C,\ unless\ otherwise\ noted.$  Typical values are at  $V_{CC}=+3.3V,\ |V_{ID}|=0.2V,\ V_{CM}=+1.25V,\ T_A=+25^{\circ}C.)$  (Notes 1, 2, 3)

| PARAMETER  | SYMBOL           | CON   | DITIONS   | MIN  | TYP   | MAX  | UNITS |
|--|------------------|---|---|------|-------|------|-------|
| Change in Offset Voltage<br>Between Logic States       | ΔV <sub>OS</sub> | Figure 3  |   |      | 1.0   | 15   | mV    |
| Fail-Safe Differential Output<br>Voltage (MAX9174)     | V <sub>OD</sub>  | Figure 2  |   | 250  | 393   | 475  | mV    |
| Differential Output Resistance                         | RDIFF            | $V_{CC} = 3.6V \text{ or } 0V$  |   | 86   | 119   | 160  | Ω     |
| Power-Down Single-Ended                                | lpD              | PD_ = low   | V <sub>OUT_+</sub> = open,<br>V <sub>OUT</sub> = 3.6V or 0V | -1.0 | +0.03 | +1.0 | μА    |
| Output Current   | IPD              | FD_ = 10W   | $V_{OUT\} = open,$<br>$V_{OUT\_+} = 3.6V \text{ or } 0V$    | -1.0 | ±0.03 | +1.0 | μΑ    |
| Power-Off Single-Ended Output                          | loff             | $\overline{PD0}$ , $\overline{PD1} = low$ ,   | V <sub>OUT_+</sub> = open,<br>V <sub>OUT</sub> = 3.6V or 0V | -1.0 | ±0.03 | +1.0 |       |
| Current  | IOFF             | V <sub>CC</sub> = 0V or open  | $V_{OUT\} = open,$<br>$V_{OUT\_+} = 3.6V \text{ or } 0V$    | -1.0 | ±0.03 | +1.0 | μА    |
| Output Short-Circuit Current                           | Ios              | Vcc   | $mV$ , $V_{OUT\_+} = 0V$ or                                 | -15  |       | +15  | mA    |
|  |                  | $V_{ID} = +50$ mV or -50r   | mV, V <sub>OUT</sub> = 0V or V <sub>CC</sub>                |      |       |      |       |
| Differential Output Short-Circuit<br>Current Magnitude | I <sub>OSD</sub> | $V_{ID} = +50$ mV or -50r   | mV, V <sub>OD</sub> = 0V (Note 4)                           |      |       | 15   | mA    |
| Supply Current   | Icc              | $\overline{PD0} = V_{CC}, \overline{PD1} = 0$ $\overline{PD0} = 0V, \overline{PD1} = V_{0}$ |   |      | 17    | 26   | mA    |
|  |                  | $\overline{PD0} = Vcc, \overline{PD1} = V$  | /cc   |      | 25    | 35   | 1     |
| Power-Down Supply Current                              | ICCPD            | PD1, PD0 = 0V   |   |      | 0.5   | 20   | μΑ    |
| Output Capacitance                                     | Co               | OUT_+ or OUT to   | GND (Note 4)  |      |       | 5.2  | pF    |

#### **AC ELECTRICAL CHARACTERISTICS**

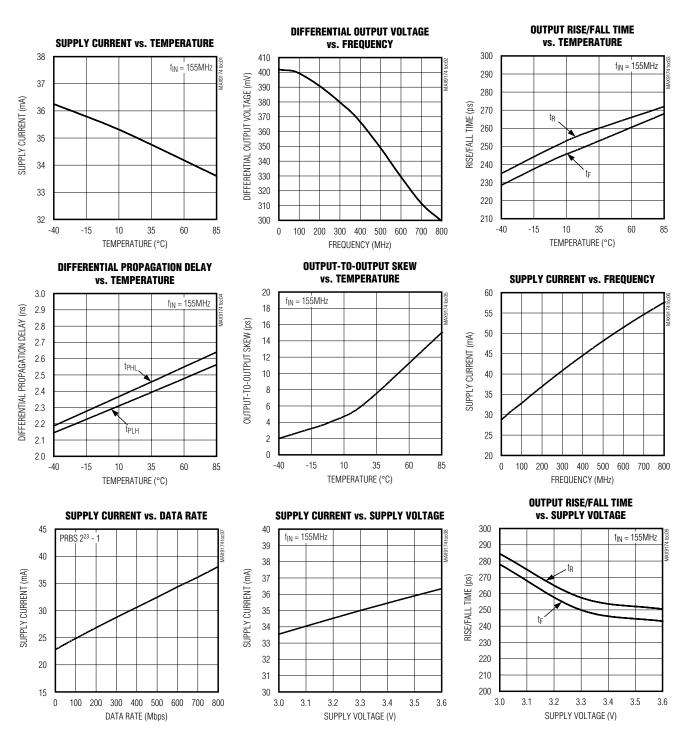
 $(V_{CC} = +3.0 \text{V to } +3.6 \text{V}, R_L = 100\Omega \pm 1\%, C_L = 5 \text{pF}, differential input voltage } IV_{ID}I = 0.15 \text{V to } 1.2 \text{V}, MAX9174 \text{ input common-mode voltage}, V_{CM} = |V_{ID}/2| \text{ to } (2.4 \text{V} - |V_{ID}/2|), MAX9175 \text{ input common-mode voltage } V_{CM} = |V_{ID}/2| \text{ to } (V_{CC} - |V_{ID}/2|), PD_ = \text{high}, T_A = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}, \text{ unless otherwise noted}. Typical values are at <math>V_{CC} = +3.3 \text{V}, |V_{ID}I = 0.2 \text{V}, V_{CM} = +1.25 \text{V}, T_A = +25 ^{\circ}\text{C}.)$  (Notes 5, 6, 7)

| PARAMETER                     | SYMBOL            | CONDITIONS  | MIN  | TYP  | MAX  | UNITS   |
|-------------------------------|-------------------|---|------|------|------|---------|
| High-to-Low Propagation Delay | tphL              | Figures 4, 5  | 1.33 | 2.38 | 3.23 | ns      |
| Low-to-High Propagation Delay | tplh              | Figures 4, 5  | 1.33 | 2.39 | 3.23 | ns      |
| Added Deterministic Jitter    | t <sub>D</sub> J  | Figures 4, 5 (Note 8)   |      |      | 80   | ps(P-P) |
| Added Random Jitter           | t <sub>RJ</sub>   | Figures 4, 5  |      |      | 1.0  | ps(RMS) |
| Pulse Skew   tplh - tphl      | tskp              | Figures 4, 5  |      | 10   | 141  | ps      |
| Output-to-Output Skew         | tskoo             | Figure 6  |      | 14   | 45   | ps      |
| Part-to-Part Skew             | tskpp1            | Figures 4, 5 (Note 9)   |      | 0.4  | 1.3  | 20      |
| Part-to-Part Skew             | tSKPP2            | Figures 4, 5 (Note 10)  |      |      | 1.9  | ns      |
| Rise Time                     | t <sub>R</sub>    | Figures 4, 5  | 110  | 257  | 365  | ps      |
| Fall Time                     | tF                | Figures 4, 5  | 110  | 252  | 365  | ps      |
| Power-Down Time               | t <sub>PD</sub>   | Figures 7, 8  |      | 10   | 13   | ns      |
|                               |                   | $\overline{PD0}$ , $\overline{PD1} = L \rightarrow H$ , Figures 7, 8  |      | 18   | 35   | μs      |
| Power-Up Time                 | tpu               | $\overline{\text{PD0}} = \text{H}, \overline{\text{PD1}} = \text{L} \rightarrow \text{H}, \text{ Figures 7, 8}$ |      | 92   | 103  | 20      |
|                               |                   | $\overline{\text{PD1}} = \text{H}, \overline{\text{PD0}} \text{L} \rightarrow \text{H}, \text{Figures 7, 8}$    |      | 92   | 103  | ns      |
| Maximum Data Rate             | D <sub>RMAX</sub> | Figures 4, 5,  V <sub>OD</sub>   ≥ 250mV (Note 11)  | 800  |      |      | Mbps    |
| Maximum Switching Frequency   | f <sub>MAX</sub>  | Figures 4, 5,  V <sub>OD</sub>   ≥ 250mV (Note 11)  | 670  |      |      | MHz     |
| Switching Supply Current      | laggu             | $f_{IN} = 670MHz$   |      | 55   | 65   | - mA    |
| Switching Supply Current      | Iccsw             | $f_{IN} = 155MHz$   |      | 35   | 44   | MA      |
| PRBS Supply Current           | ICCPR             | D <sub>R</sub> = 800Mbps, 2 <sup>23</sup> - 1 PRBS input  |      | 37   | 46   | mA      |

- Note 1: Current into a pin is defined as positive. Current out of a pin is defined as negative. All voltages are referenced to ground except  $V_{TH}$ ,  $V_{TL}$ ,  $V_{ID}$ ,  $V_{OD}$ , and  $\Delta V_{OD}$ .
- **Note 2:** Maximum and minimum limits over temperature are guaranteed by design and characterization. Devices are 100% tested at  $T_A = +25$ °C.
- Note 3: Tolerance on all external resistors (including figures) is  $\pm 1\%$ .
- Note 4: Guaranteed by design.
- Note 5: AC parameters are guaranteed by design and characterization and are not production tested. Limits are set at ±6 sigma.
- **Note 6:** C<sub>L</sub> includes scope probe and test jig capacitance.
- Note 7: Pulse-generator output for differential inputs IN+, IN- (unless otherwise noted): f = 670MHz, 50% duty cycle, R<sub>O</sub> = 50Ω, t<sub>R</sub> = 700ps, and t<sub>F</sub> = 700ps (0% to 100%). Pulse-generator output for single-ended inputs PDO, PD1: t<sub>R</sub> = t<sub>F</sub> = 1.5ns (0.2V<sub>CC</sub> to 0.8V<sub>CC</sub>), 50% duty cycle, V<sub>OH</sub> = V<sub>CC</sub> + 1.0V settling to V<sub>CC</sub>, V<sub>OL</sub> = -1.0V settling to zero, f = 10kHz.
- **Note 8:** Pulse-generator output for  $t_{DJ}$ :  $|V_{OD}| = 0.15V$ ,  $V_{OS} = 1.25V$ , data rate 800Mbps,  $2^{23}$  1 PRBS,  $R_O = 50\Omega$ ,  $t_R = 700$ ps, and  $t_F = 700$ ps (0% to 100%).
- **Note 9:** tsKPP1 is the magnitude of the difference of any differential propagation delays between devices operating under identical conditions.
- Note 10: tskPP2 is the magnitude of the difference of any differential propagation delays between devices operating over rated conditions.
- Note 11: Meets all AC specifications.

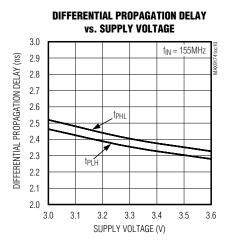
### **Typical Operating Characteristics**

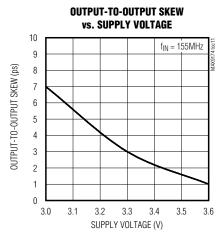
 $((MAX9174) V_{CC} = +3.3V, |V_{ID}| = 0.15V, V_{CM} = 1.25V, T_{A} = +25^{\circ}C, R_{L} = 100\Omega \pm 1\%, C_{L} = 5pf, \overline{PD}_{L} = V_{CC}, unless otherwise noted.)$ 

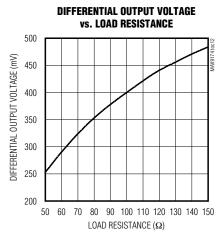


### Typical Operating Characteristics (continued)

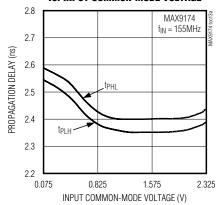
 $((MAX9174) V_{CC} = +3.3V, |V_{ID}| = 0.15V, V_{CM} = 1.25V, T_A = +25^{\circ}C, R_L = 100\Omega \pm 1\%, C_L = 5pf, \overline{PD}_{-} = V_{CC}, unless otherwise noted.)$ 



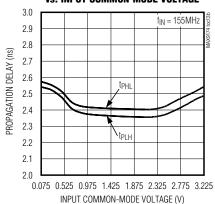




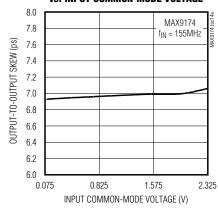
PROPAGATION DELAY vs. INPUT COMMON-MODE VOLTAGE



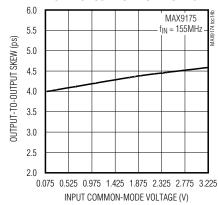




OUTPUT-TO-OUTPUT SKEW vs. INPUT COMMON-MODE VOLTAGE



OUTPUT-TO-OUTPUT SKEW vs. INPUT COMMON-MODE VOLTAGE



### **Pin Description**

|      | PIN | NAME           | FUNCTION  |
|------|-----|----------------|---|
| μМΑХ | QFN | INAIVIE        | FUNCTION  |
| 1    | 1   | IN+            | Noninverting Differential Input   |
| 2    | 2   | IN-            | Inverting Differential Input  |
| 3    | 3   | GND            | Ground  |
| 4    | 4   | PD1            | LVTTL/LVCMOS Input. OUT1+, OUT1- are high impedance to ground when PD1 is low. Internal pulldown resistor to GND. |
| 5    | 5   | PD0            | LVTTL/LVCMOS Input. OUT0+, OUT0- are high impedance to ground when PD0 is low. Internal pulldown resistor to GND. |
| 6    | 6   | OUT0-          | Inverting LVDS Output 0   |
| 7    | 7   | OUT0+          | Noninverting LVDS Output 0  |
| 8    | 8   | Vcc            | Power Supply  |
| 9    | 9   | OUT1-          | Inverting LVDS Output 1   |
| 10   | 10  | OUT1+          | Noninverting LVDS Output 1  |
| _    | EP  | Exposed<br>Pad | Exposed Pad. Solder to ground.  |

### **Detailed Description**

The MAX9174/MAX9175 are 670MHz, low-jitter, low-skew 1:2 splitters ideal for protection switching, loop-back, and clock and signal distribution. The devices feature ultra-low  $80psp_p$  deterministic jitter (max) that ensures reliable operation in high-speed links that are highly sensitive to timing error.

The MAX9174 has a fail-safe LVDS input and LVDS outputs. The MAX9175 has an anything differential input (CML/LVDS/LVPECL) and LVDS outputs. The outputs can be put into high impedance using the power-down inputs. The MAX9174 features a fail-safe circuit that drives the outputs high when the input is open, undriven and shorted, or undriven and terminated. The MAX9175 has a bias circuit that forces the outputs high when the input is open. The power-down inputs are compatible with standard LVTTL/LVCMOS logic.

The power-down inputs tolerate undershoot of -1V and overshoot of VCC + 1V. The MAX9174/MAX9175 are available in 10-pin  $\mu$ MAX and 10-lead thin QFN packages, and operate from a single +3.3V supply over the -40°C to +85°C temperature range.

#### **Current-Mode LVDS Outputs**

The LVDS outputs use a current-steering configuration. This approach results in less ground bounce and less output ringing, enhancing noise margin and system speed performance.

A differential output voltage is produced by steering current through the parallel combination of the integrated differential output resistor and transmission line impedance/termination resistor. When driving a  $100\Omega$  termination resistor, a differential voltage of 250mV to 475mV is produced. For loads greater than  $100\Omega$ , the output voltage is larger, and for loads less than  $100\Omega$ , the output voltage is smaller. See the Differential Output Voltage vs. Load Resistance curve in Typical Operating Characteristics for more information. The outputs are short-circuit current limited for single-ended and differential shorts.

#### MAX9174 Input Fail-Safe

The fail-safe feature of the MAX9174 sets the outputs high when the differential input is:

- Open
- Undriven and shorted
- Undriven and terminated

Without a fail-safe circuit, when the input is undriven, noise at the input may switch the outputs and it may appear to the system that data is being sent. Open or undriven terminated input conditions can occur when a cable is disconnected or cut, or when a driver output is in high impedance. A shorted input can occur because of a cable failure.

When the input is driven with a differential signal of IV<sub>IDI</sub> = 50mV to 1.2V within a voltage range of 0 to 2.4V, the fail-safe circuit is not activated. If the input is open, undriven and shorted, or undriven and terminated, an internal resistor in the fail-safe circuit pulls the input above VCC - 0.3V, activating the fail-safe circuit and forcing the outputs high (Figure 1).

#### Overshoot and Undershoot Voltage Protection

The MAX9174/MAX9175 are designed to protect the power-down inputs (PD0 and PD1) against latchup due to transient overshoot and undershoot voltage. If the input voltage goes above VCC or below GND by up to 1V, an internal circuit limits input current to 1.5mA.

### Applications Information

#### **Power-Supply Bypassing**

Bypass the V<sub>CC</sub> pin with high-frequency surface-mount ceramic  $0.1\mu F$  and  $0.001\mu F$  capacitors in parallel as close to the device as possible, with the smaller valued capacitor closest to V<sub>CC</sub>.

#### **Differential Traces**

Input and output trace characteristics affect the performance of the MAX9174/MAX9175. Use controlled-impedance differential traces ( $100\Omega$  typ). To reduce radiated noise and ensure that noise couples as common mode, route the differential input and output signals within a pair close together. Reduce skew by matching the electrical length of the two signal paths that make up the differential pair. Excessive skew can result in a degradation of magnetic field cancellation. Maintain a constant distance between the differential traces to avoid discontinuities in differential impedance. Minimize the number of vias to further prevent impedance discontinuities.

#### **Cables and Connectors**

Interconnect for LVDS typically has a controlled differential impedance of  $100\Omega$ . Use cables and connectors that have matched differential impedance to minimize impedance discontinuities.

Avoid the use of unbalanced cables such as ribbon or simple coaxial cable. Balanced cables such as twisted pair offer superior signal quality and tend to generate less EMI due to magnetic field canceling effects. Balanced cables pick up noise as common mode, which is rejected by the LVDS receiver.

#### **Termination**

The MAX9174/MAX9175 require external input and output termination resistors. For LVDS, connect an input

**Table 1. Input Function Table** 

|          | INPUT  | OUTPUTS         |
|----------|--|-----------------|
| (I)      | I+) - (IN-)  | (OUT_+) - (OUT) |
| ≥        | +50mV  | Н               |
| <u> </u> | :-50mV   | L               |
| -50mV <  | : VID < +50mV  | Indeterminate   |
| MAX9175  | Open   |                 |
| MAX9174  | Open, undriven short, or undriven parallel termination | н               |

**Table 2. Power-Down Function Table** 

| PD1       | PD0       | OUT_+, OUT  |
|-----------|-----------|---|
| Н         | Н         | Both outputs enabled  |
| L or open | L or open | Shutdown to minimum power, outputs high impedance to ground |
| L or open | High      | OUT0 enabled, OUT1 high impedance to ground                 |
| High      | L or open | OUT1 enabled, OUT0 high impedance to ground                 |

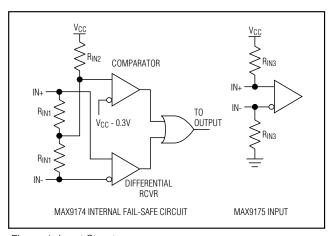


Figure 1. Input Structure

termination resistor across the differential input and at the far end of the interconnect driven by the LVDS outputs. Place the input termination resistor as close to the receiver input as possible. Termination resistors should match the differential impedance of the transmission line. Use 1% surface-mount resistors.

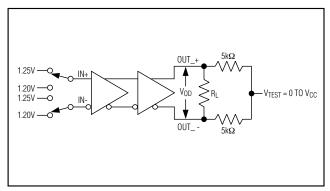


Figure 2. VOD Test Circuit

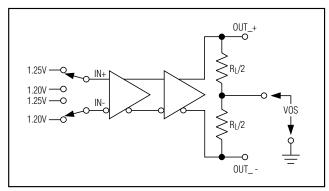


Figure 3. Vos Test Circuit

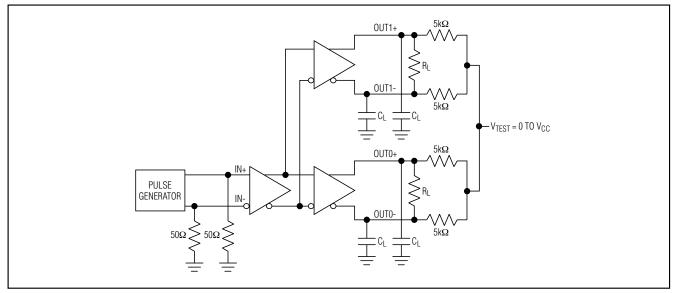


Figure 4. Transition Time, Propagation Delay, and Output-to-Output Skew Test Circuit

The MAX9174/MAX9175 feature an integrated differential output resistor. This resistor reduces jitter by damping reflections produced by a mismatch between the transmission line and termination resistor at the far end of the interconnect.

#### **Board Layout**

Separate the differential and single-ended signals to reduce crosstalk. A four-layer printed circuit board with separate layers for power, ground, differential signals, and single-ended logic signals is recommended. Separate the differential signals from the logic signals with power and ground planes for best results.

# IEC 61000-4-2 Level 4 ESD Protection

The IEC 61000-4-2 standard (Figure 9) specifies ESD tolerance for electronic systems. The IEC 61000-4-2 model specifies a 150pF capacitor that is discharged into the device through a 330 $\Omega$  resistor. The MAX9174/ MAX9175 differential inputs and outputs are rated for IEC 61000-4-2 level 4 (±8kV Contact Discharge and ±15kV Air-Gap Discharge). The Human Body Model (HBM, Figure 10) specifies a 100pF capacitor that is discharged into the device through a 1.5k $\Omega$  resistor. IEC 61000-4-2 level 4 discharges higher peak current and more energy than the HBM due to the lower series resistance and larger capacitor.

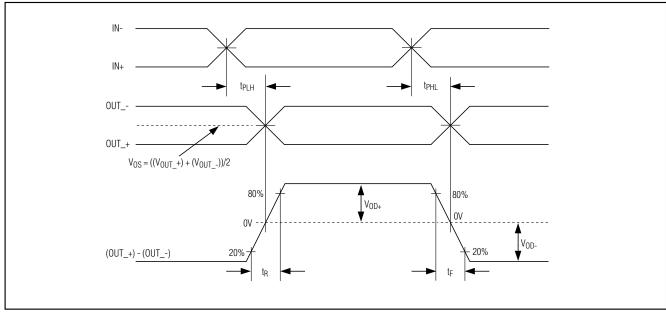


Figure 5. Transition Time and Propagation Delay Timing

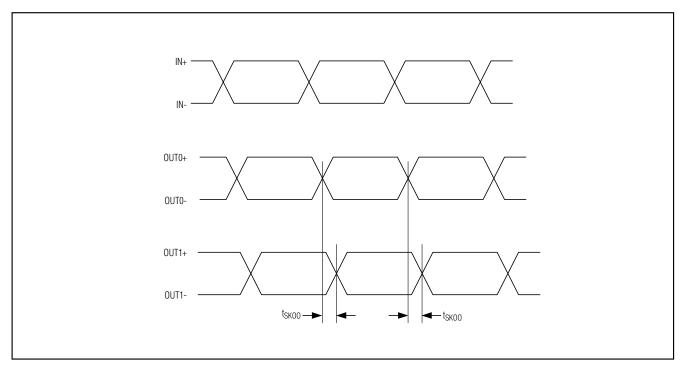


Figure 6. Output-to-Output Skew

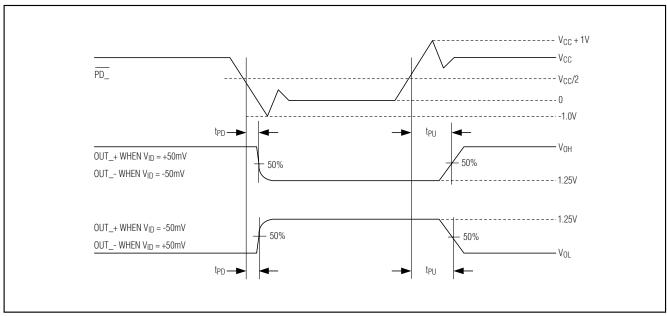


Figure 7. Power-Up/Down Delay Waveform

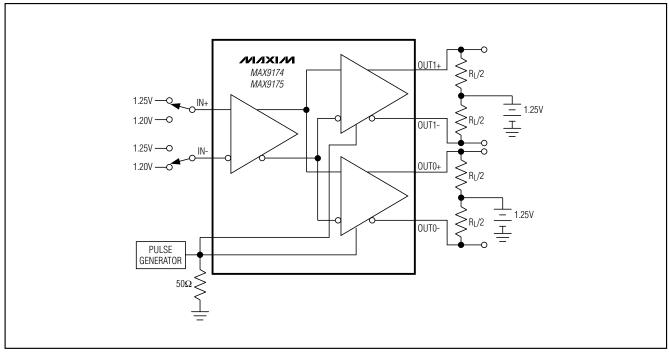


Figure 8. Power-Up/Down Delay Test Circuit

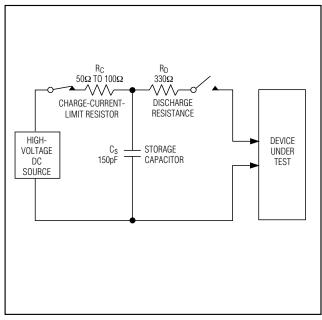


Figure 9. IEC 61000-4-2 Contact Discharge ESD Test Model

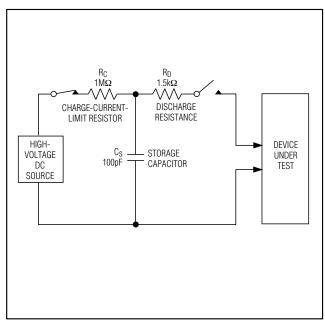
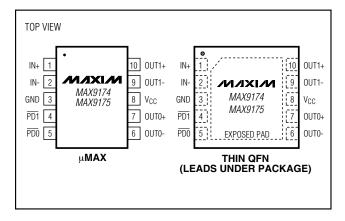
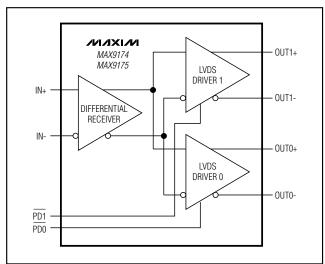


Figure 10. Human Body ESD Test Model

### **Pin Configurations**



### \_Functional Diagram



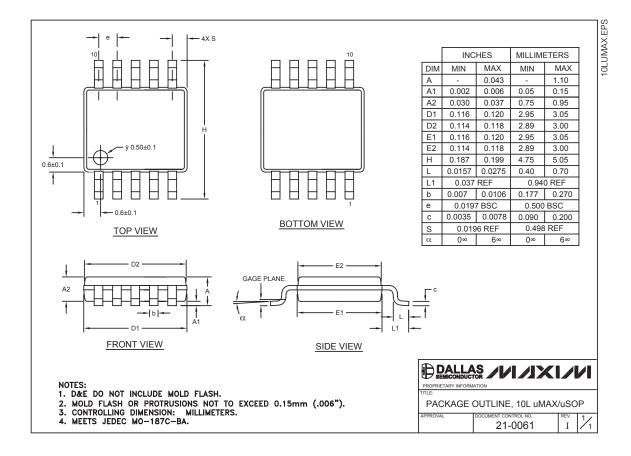
### **Chip Information**

TRANSISTOR COUNT: 693

PROCESS: CMOS

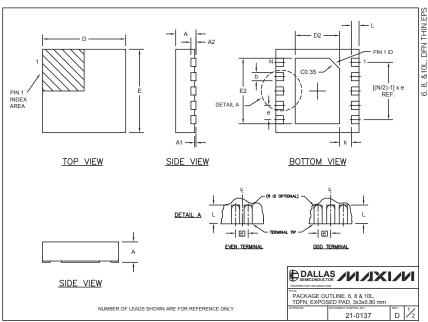
### Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



| COMMO                              | N DIME            | NSIONS          | 1               |               |                            |                |               |  |
|------------------------------------|-------------------|-----------------|-----------------|---------------|----------------------------|----------------|---------------|--|
| SYMBOL                             | MIN.              | MAX.            | 1               |               |                            |                |               |  |
| A                                  | 0.70              | 0.80            | 1               |               |                            |                |               |  |
| D                                  | 2.90              | 3.10            | 1               |               |                            |                |               |  |
| E                                  | 2.90              | 3.10            | 1               |               |                            |                |               |  |
| A1                                 | 0.00              | 0.05            | ]               |               |                            |                |               |  |
| L                                  | 0.20              | 0.40            | ]               |               |                            |                |               |  |
| k                                  |                   | 25 MIN.         |                 |               |                            |                |               |  |
| A2                                 |                   |                 |                 |               |                            |                |               |  |
| PACKAGE VAR                        | IATIONS<br>N      | D2              | E2              | e             | JEDEC SPEC                 | ь              | [(N/2)-1] x e |  |
| PACKAGE VAR                        | IATIONS           |                 | E2<br>2.30±0.10 | e<br>0.95 BSC | JEDEC SPEC<br>MO229 / WEEA | b<br>0.40±0.05 | 1.90 REF      |  |
| PACKAGE VAR                        | IATIONS<br>N      | D2              |                 |               |                            | -              | *             |  |
| PACKAGE VAR<br>PKG. CODE<br>T633-1 | IATIONS<br>N<br>6 | D2<br>1.50±0.10 | 2.30±0.10       | 0.95 BSC      | MO229 / WEEA               | 0.40±0.05      | 1.90 REF      |  |

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DS90C383MTDX/NOPB DS90C383MTD DS90LV031ATMTC DS90C402M SN65LVDS051PWRQ1 DS90C387VJDXNOPB
SN65LVDT32BDR ADN4665ARUZ ADN4666ARUZ ADN4666ARZ-REEL7 ADN4692EBRZ ADN4693EBRZ ADN4697EBRZ
ADN4695EBRZ ADN4665ARZ ADN4666ARZ ADN4667ARZ ADN4667ARZ-REEL7 ADN4668ARZ ADN4670BSTZ ADN4670BCPZ
ADN4661BRZ ADN4663BRZ-REEL7 ADN4694EBRZ-RL7 ADN4662BRZ-REEL7 ADN4662BRZ ADN4691EBRZ ADN4694EBRZ
ADN4690EBRZ ADN4661BRZ-REEL7 MAX9113ESA+ GM8285BGA MAX9113ESA+T MAX9111ESA+T MAX9112ESA+T
MAX9122EUE+T MAX9174EUB+T